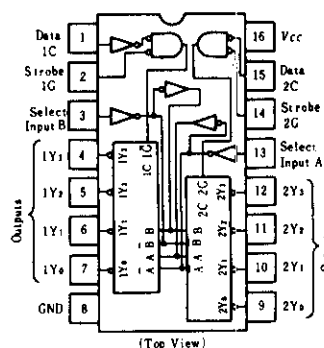


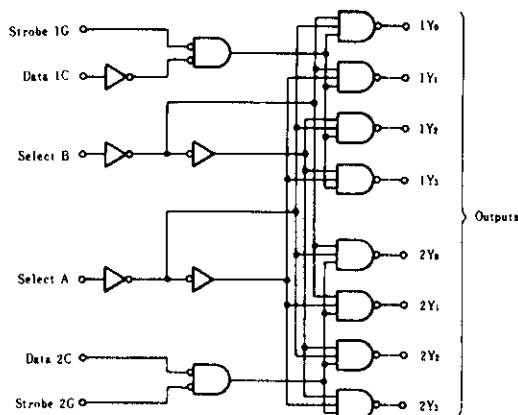
HD74LS156 ●Dual 2-line-to-4-line Decoders/Demultiplexers (with open collector outputs)

This circuit features dual 1-line-to-4-line demultiplexer with individual strobes and common binary-address inputs. When both sections are enabled by the strobes, the common binary-address inputs sequentially select and route associated input data to the appropriate output of each section. The individual strobes permit activating or inhibiting each of the 4-bit sections as desired. Data applied to input 1C is inverted through its outputs. The inverter following the 1C data input permits use as a 3-to-8-line decoder or 1-to-8-line demultiplexer without external gating.

■PIN ARRANGEMENT



■BLOCK DIAGRAM



■RECOMMENDED OPERATING CONDITIONS

Item	Symbol	min	typ	max	Unit
High level output voltage	V_{OH}	—	—	5.5	V
Low level output current	I_{OL}	—	—	8	mA

■FUNCTION TABLE

●2-to-4-line Decoder/1-to-4-line Demultiplexer

Inputs				Outputs				Inputs				Outputs			
SELECT	STROBE	DATA						SELECT	STROBE	DATA					
B	A	1G	1C	1Y0	1Y1	1Y2	1Y3	B	A	2G	2C	2Y0	2Y1	2Y2	2Y3
X	X	H	X	H	H	H	H	X	X	H	X	H	H	H	H
L	L	L	H	L	H	H	H	L	L	L	L	L	H	H	H
L	H	L	H	H	L	H	H	L	H	L	L	H	L	H	H
H	L	L	H	H	H	L	H	H	L	L	L	H	H	L	H
H	H	L	H	H	H	H	L	H	H	L	L	H	H	H	L
X	X	X	L	H	H	H	H	X	X	X	H	H	H	H	H

●3-to-8-line Decoder/1-to-8-line Demultiplexer

Inputs			Outputs								
SELECT			STROBE OR DATA	(0)	(1)	(2)	(3)	(4)	(5)	(6)	(7)
C ⁽¹⁾	B	A	G ⁽²⁾	2Y0	2Y1	2Y2	2Y3	1Y0	1Y1	1Y2	1Y3
X	X	X	H	H	H	H	H	H	H	H	H
L	L	L	L	L	H	H	H	H	H	H	H
L	L	H	L	H	L	H	H	H	H	H	H
L	H	L	L	H	H	L	H	H	H	H	H
L	H	H	L	H	H	H	L	H	H	H	H
H	L	L	L	H	H	H	H	L	H	H	H
H	L	H	L	H	H	H	H	H	L	H	H
H	H	L	L	H	H	H	H	H	H	L	H
H	H	H	L	H	H	H	H	H	H	H	L

- Notes) 1. C; input 1C and 2C connected together
 2. G; inputs 1G and 2G connected together
 3. H; high level, L; low level, X; irrelevant

HD74LS156

ELECTRICAL CHARACTERISTICS (Ta = -20 ~ +75°C)

Item	Symbol	Test Conditions	min	typ*	max	Unit
Input voltage	V_{IH}		2.0	—	—	V
	V_{IL}		—	—	0.8	V
Output current	I_{OH}	$V_{CC}=4.75V, V_{IH}=2V, V_{IL}=0.8V, V_{OH}=5.5V$	—	—	100	μA
Output voltage	V_{OL}	$V_{CC}=4.75V, V_{IH}=2V, V_{IL}=0.8V$	$I_{OL}=4mA$	—	0.4	V
			$I_{OL}=8mA$	—	0.5	
Input current	I_{IH}	$V_{CC}=5.25V, V_I=2.7V$	—	—	20	μA
	I_{IL}	$V_{CC}=5.25V, V_I=0.4V$	—	—	-0.4	mA
	I_i	$V_{CC}=5.25V, V_I=7V$	—	—	0.1	mA
Supply current**	I_{CC}	$V_{CC}=5.25V$	—	6.1	10	mA
Input clamp voltage	V_{IK}	$V_{CC}=4.75V, I_{IN}=-18mA$	—	—	-1.5	V

* $V_{CC}=5V, T_a=25^\circ C$

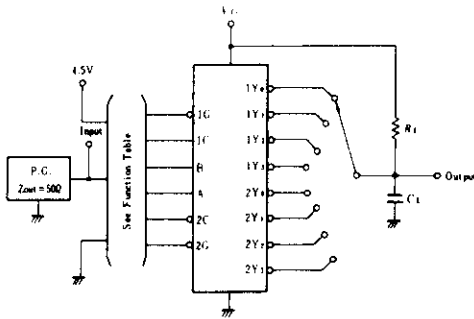
** I_{CC} is measured with outputs open, A, B, and 1C inputs at 4.5V, and 2C, 1G, and 2G inputs grounded.

SWITCHING CHARACTERISTICS (VCC = 5V, Ta = 25°C)

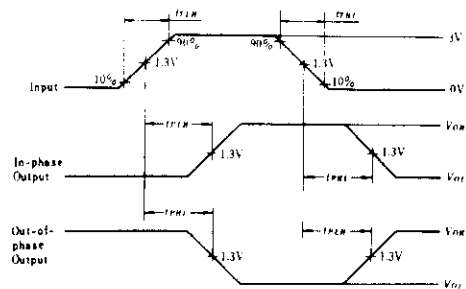
Item	Symbol	Inputs	Output	Level of logic	Test Conditions	min	typ	max	Unit
Propagation delay time	t_{PLH}	A, B, 2C, 1G or 2G	Y	2	$C_L = 15pF,$ $R_L = 2k\Omega$	—	25	40	ns
	t_{PHL}	A, B, 2C, 1G or 2G	Y	2		—	34	51	
	t_{PLH}	A or B	Y	3		—	31	46	
	t_{PHL}	A or B	Y	3		—	34	51	
	t_{PLH}	1C	Y	3		—	32	48	
	t_{PHL}	1C	Y	3		—	32	48	

TESTING METHOD

1) Test Circuit

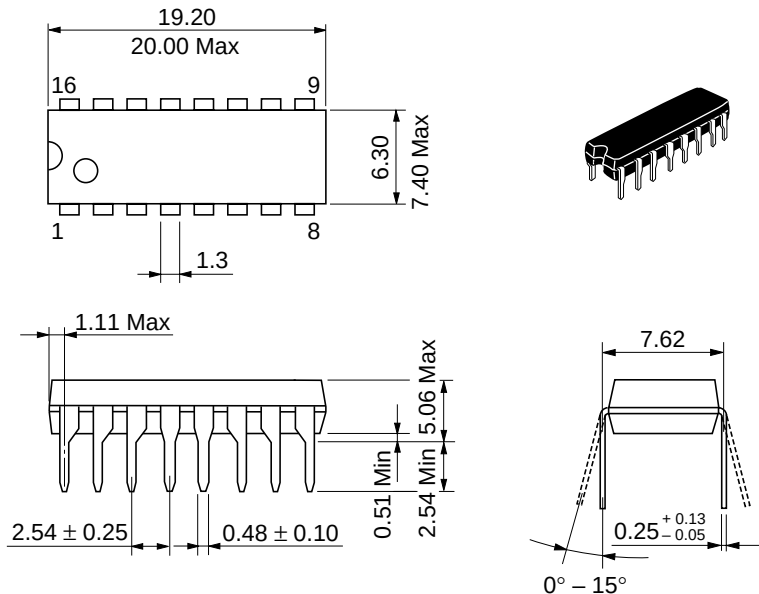


Waveform

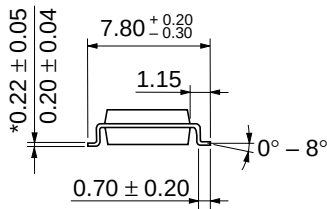
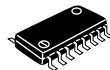
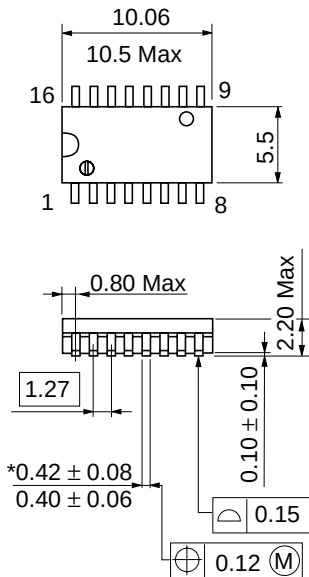


- Notes) 1. Input pulse: $t_{TLH} \leq 15ns, t_{THL} \leq 6ns, PRR=1MHz,$
duty cycle=50%.
2. C_L includes probe and jig capacitance.

Unit: mm

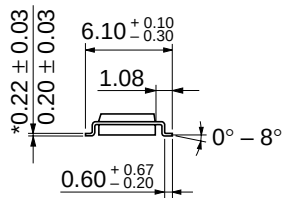
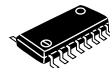
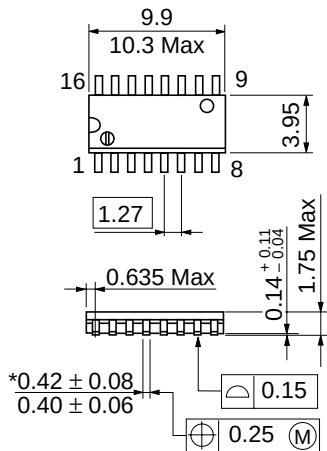


Hitachi Code	DP-16
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	1.07 g



*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.24 g



*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.15 g

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Hitachi, Ltd.

Semiconductor & Integrated Circuits.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

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For further information write to:

Hitachi Semiconductor (America) Inc. 179 East Tasman Drive, San Jose, CA 95134 Tel: <1> (408) 433-1990 Fax: <1> (408) 433-0223	Hitachi Europe GmbH Electronic components Group Dornacher Straße 3 D-85622 Feldkirchen, Munich Germany Tel: <49> (89) 9 9180-0 Fax: <49> (89) 9 29 30 00 Hitachi Europe Ltd. Electronic Components Group. Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA, United Kingdom Tel: <44> (1628) 585000 Fax: <44> (1628) 778322
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Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 049318 Tel: 535-2100 Fax: 535-1533 Hitachi Asia Ltd. Taipei Branch Office 3F, Hung Kuo Building, No.167, Tun-Hwa North Road, Taipei (105) Tel: <886> (2) 2718-3666 Fax: <886> (2) 2718-8180
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Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218
Fax: <852> (2) 730 0281
Telex: 40815 HITEC HX

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